LUMILEDS

GENERAL ILLUMINATION

LUXEON 3535 2D

High flux in a 3535 package with full range of CCTs and CRIs

LUXEON 3535 2D is a mid-power LED delivering optimized performance in combination with the Quality of Light needed for distributed light source applications. In addition, the product comes in specified correlated color temperature and color rendering combinations for high brightness systems while improving system lm/$. LUXEON 3535 2D emitters deliver the efficacy and reliability required by the indoor and outdoor illumination markets.

FEATURES AND BENEFITS

- Industry standard package enables drop-in replacement for existing 3535 packages
- High efficacy for sustainable designs
- 80CRI minimum and R9>0 for quality indoor lighting
- 1/6th and 1/9th ANSI color binning delivers tight color control
- Full range of CCTs and CRIs

PRIMARY APPLICATIONS

- Architectural
- Downlights
- High Bay & Low Bay
- Indoor Area Lighting
- Lamps
- Outdoor
- Specialty Lighting
- Spotlights

Table of Contents

General Information

Part Number Nomenclature

LUXEON Mid-Power Illumination emitters are tested and binned at 100mA, with current pulse duration of 20ms. All characteristic charts where the thermal pad is kept at constant temperature (25°C typically) are measured with current pulse duration of 20ms. Under these conditions, junction temperature and thermal pad temperature are the same.

The part number designations for the MXCA series is explained as follows:

M X C A - B C D E - I J K L

Where:

A	—	designates minimum CRI performance (value 7 = 70 minimum and 8 = 80 minimum)
B	—	designates radiation pattern (value P = Lambertian)
C	—	designates color (value W = White)
D, E	—	designates nominal ANSI CCT (for example, 30 = 3000K and 40 = 4000K)
I, J, K & L	—	additional part number designation

Therefore products in this series with minimum CRI value of 80, CCT of 4000K will have the part numbering scheme:

M X C 8 - P W 4 0 - 0 0 0 0

Average Lumen Maintenance Characteristics

Lumen maintenance for solid-state lighting devices (LEDs) is typically defined in terms of the percentage of initial light output remaining after a specified period of time. LM-80 test reports are available upon request.

Environmental Compliance

Lumileds is committed to providing environmentally friendly products to the solid-state lighting market. LUXEON Mid-Power LEDs are compliant to the European Union directives on the restriction of hazardous substances in electronic equipment, namely REACH and the RoHS directive. Lumileds will not intentionally add the following restricted materials to these LEDs: lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) or polybrominated diphenyl ethers (PBDE).

Product Selection

Product Selection for Mid-Power LEDs
Solder Pad Temperature = 25°C, Test Current = 100mA

Table 1.

Nominal CCT	Part Number	Minimum CRI	Typical CRI	R9	Min Luminous Flux (lm) ϕ_v	Typ Luminous Flux (lm) ϕ_v
2700K	MXC8-PW27-0000	80	82	R9>0	55	80
	MXC9-PW27-1111	85	90	R9>50	50	68
	MXC9-PW27-0000	90	92	R9>50	50	68
3000K	MXC8-PW30-0000	80	82	R9>0	55	80
	MXC9-PW30-1111	85	90	R9>50	50	68
	MXC9-PW30-0000	90	92	R9>50	50	68
3500K	MXC8-PW35-0000	80	82	R9>0	55	80
	MXC9-PW35-0000	85	90	typ 50	50	68
4000K	MXC7-PW40-0000	70	72	-	70	77
	MXC8-PW40-0000	80	82	R>0	60	82
	MXC9-PW40-0000	85	90	typ 50	55	65
5000K	MXC7-PW50-0000	70	72	-	70	77
	MXC8-PW50-0000	80	82	R>0	60	83
5700K	MXC7-PW57-0000	70	72	-	70	77
	MXC8-PW57-0000	80	82	R>0	60	73
6500K	MXC7-PW65-0000	70	72	-	70	77
	MXC8-PW65-0000	80	82	R9>0	60	81
	MXC9-PW65-0000	86	90	R9>46	60	76

Note for Table 1:

1. Lumileds maintains a tolerance of ±7.5% on luminous flux and ±2 on CRI measurements.

Optical Characteristics

Optical Characteristics of Mid-Power LEDs
Solder Pad Temperature = 25°C, Test Current = 100mA

Table 2.

Nominal CCT	Color Temperature CCT			Typical Total Included Angle [1] (degrees) $\theta_{0.90V}$	Typical Viewing Angle [2] (degrees) 2θ ½
	Minimum	Typical	Maximum		
2700K	2550K	2700K	2850K	150	115
3000K	2850K	3000K	3200K	150	115
3500K	3200K	3500K	3750K	150	115
4000K	3750K	4000K	4250K	150	115
5000K	4700K	5000K	5300K	150	115
5700K	5300K	5700K	6000K	150	115
6500K	6000K	6500K	7000K	150	115

Notes for Table 2:
1. Total angle at which 90% of total luminous flux is captured.
2. Viewing angle is the off axis angle from lamp centerline where the luminous intensity is ½ of the peak value.

Electrical Characteristics

Electrical Characteristics of Mid-Power LEDs
Thermal Pad Temperature = 25°C, Test Current = 100mA

Table 3.

Part Number	Forward Voltage V_f [1] (V)			Typical Temperature Coefficient of Forward Voltage [2] (mV/°C) $\Delta V_F / \Delta T_J$	Typical Thermal Resistance Junction to Solder Pad (°C/W) $R\theta_{J-C}$
	Minimum	Typical	Maximum		
MXCx-PWxx-0000	5.6	6.1	6.8	-2.0 to -4.0	18

Notes for Table 3:
1. Lumileds maintains a tolerance of ±0.10V on forward voltage measurements.
2. Measured at T_j between 25°C and 110°C.

Absolute Maximum Ratings

Table 4.

Parameter	Maximum Performance
DC Forward Current (mA) [1]	200
Peak Pulsed Forward Current (mA)	240
ESD Sensitivity	Class 2 HBM per ANSI/ESDA/JEDEC JS-001-2012 Pass 400V MM per JEDEC JESD22-A115C
LED Junction Temperature [2]	125°C
Operating Case Temperature at 100 mA	-40°C - 105°C
Storage Temperature	-40°C - 105°C
Soldering Temperature	JEDEC 020D 260°C
Allowable Reflow Cycles	3
Reverse Voltage (Vr) [3], [4]	-5V

Notes for Table 4:

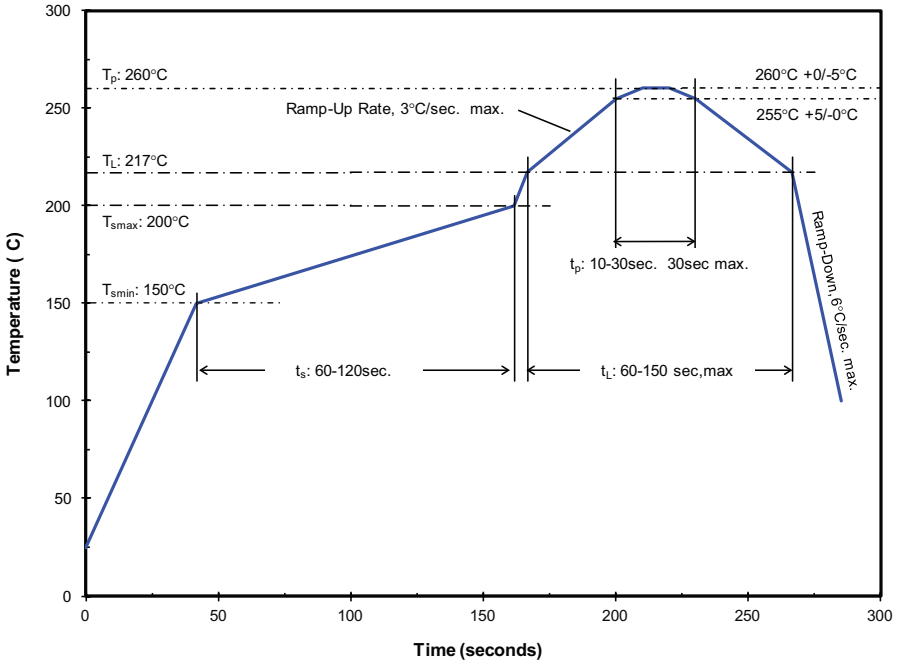
1. Ripple current with a frequency of 50-150 Hz is allowed, as long as the average of the current waveform is below 200mA, and the maximum of the current waveform is lower than 200mA.
2. Proper current derating must be observed to maintain junction temperature below the maximum.
3. LUXEON Mid-Power LEDs are not designed to be driven in reverse bias.
4. At maximum reverse current of 10µA.

JEDEC Moisture Sensitivity

Table 5.

Level	Floor Life		Soak Requirements Standard	
	Time	Conditions	Time	Conditions
2	1 year	≤ 30°C / 60% RH	168 Hrs. + 5 / - 0 Hrs.	≤85°C / 60% RH

Reflow Soldering Characteristics



Temperature profile for Table 6.

Table 6. Reflow Profile in Accordance with J-Std-020D.

Profile Feature	Lead Free Assembly
Preheat/Soak : Temperature Min (T_{smin}) Temperature Max (T_{smax}) Maximum Time (t_s) from T_{smin} to T_{smax}	 150°C 200°C 120 seconds
Ramp-up Rate (T_L to T_p)	3°C / second
Liquidous Temperature (T_L)	217°C
Maximum Time (t_L) Maintained above T_L	150 seconds
Maximum Peak Package Body Temperature (T_p)	260°C
Time (t_p) within 5°C of the specified temperature (T_c)	10-30 seconds
Maximum Ramp-Down Rate (T_p to T_L)	6°C / second
Maximum Time 25°C to Peak Temperature	8 minutes

Note for Table 6:

1. All temperatures refer to the application Printed Circuit Board (PCB), measured on the surface adjacent to the package body.

Mechanical Dimensions

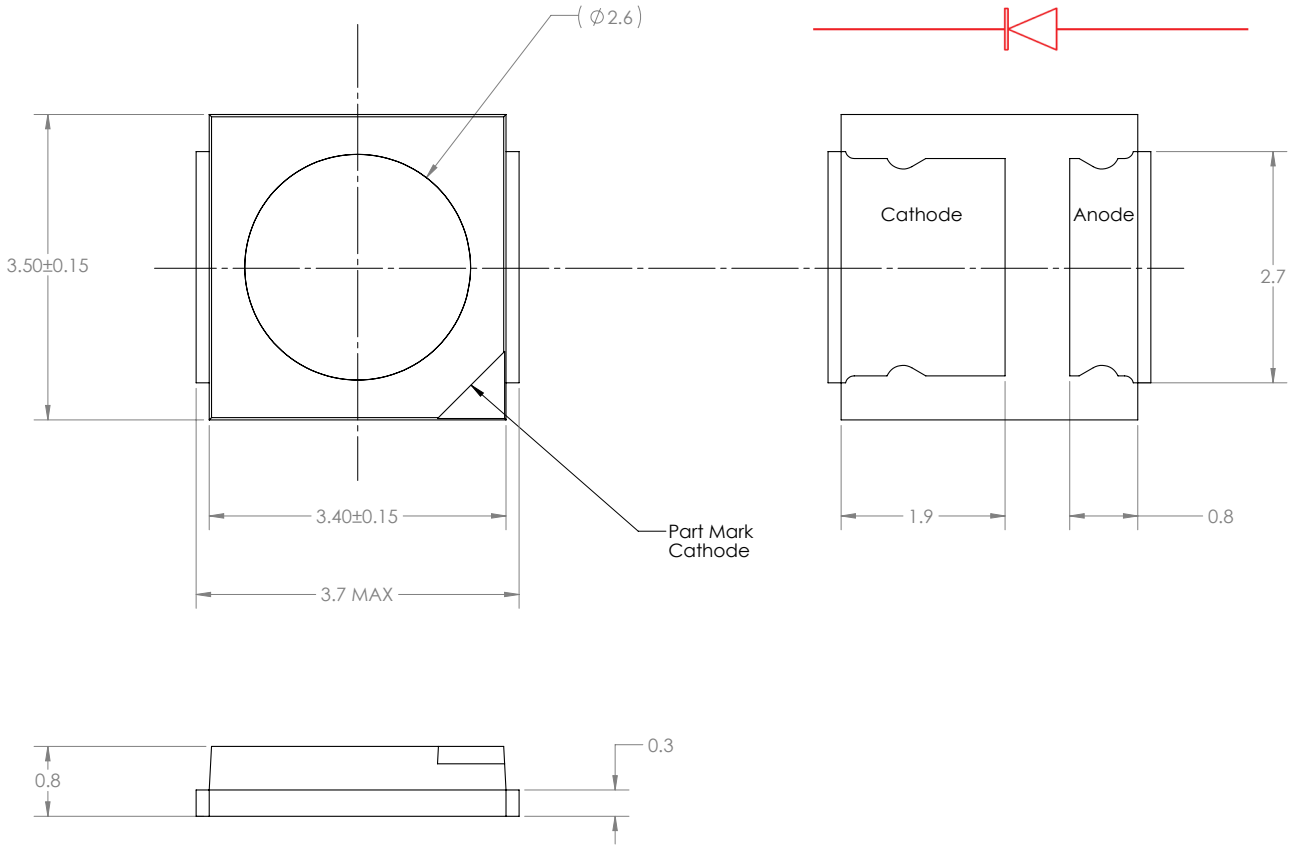


Figure 1. Package outline drawing.

Notes for Figure 1:

1. All dimensions are in millimeters.
2. Tolerance: ±0.10mm.
3. Materials
   - Lead Frame: Copper Alloy with Silver Plating
   - Package Body: High Temperature Thermal Plastic
   - Encapsulant: Silicone Resin
   - Solder Lead Finish: Sn-Sn Plating

Solder Pad Design

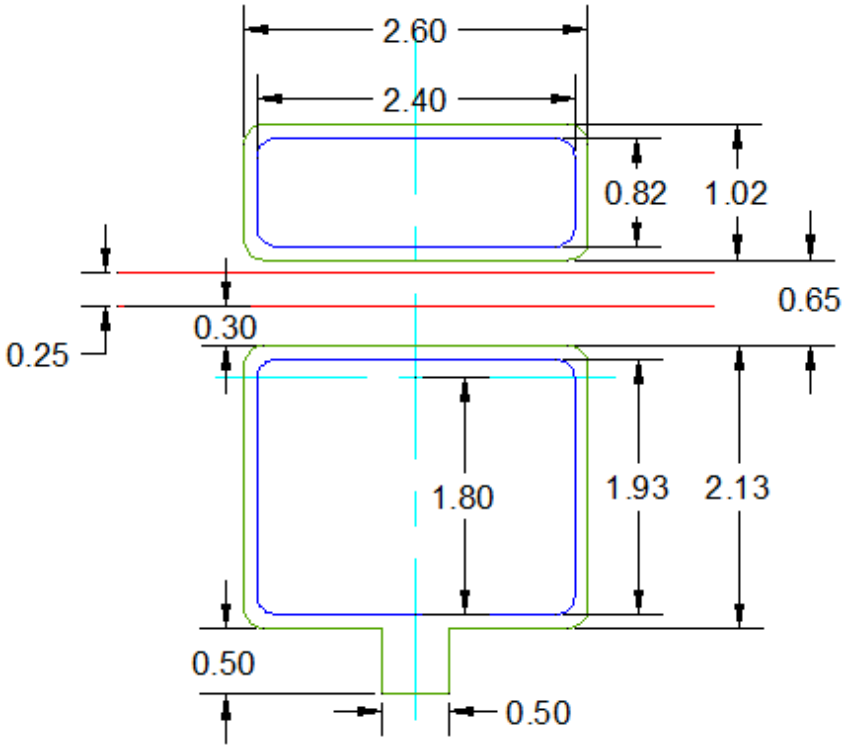


Figure 2. Solder pad layout.

Notes for Figure 2:
1. The drawing above shows the recommended solder pad layout on Printed Circuit Board (PCB).
2. Application Brief AB204 (to be released) provides extensive details for this layout. In addition, the .dwg files are available at www.lumileds.com.

Assembly Precautions

The LUXEON emitter package contains a silicone overcoat to protect the LED chip and extract the maximum amount of light. As with most silicones used in LED optics, care must be taken to prevent any incompatible chemicals from directly or indirectly reacting with the silicone.

The silicone overcoat used in the LUXEON emitter is gas permeable. Consequently, oxygen and volatile organic compound (VOC) gas molecules can diffuse into the silicone overcoat. VOCs may originate from adhesives, solder fluxes, conformal coating materials, potting materials and even some of the inks that are used to print the PCBs.

Some VOCs and chemicals react with silicone and produce discoloration and surface damage. Other VOCs do not chemically react with the silicone material directly but diffuse into the silicone and oxidize during the presence of heat or light. Regardless of the physical mechanism, both cases may affect the total LED light output. Since silicone permeability increases with temperature, more VOCs may diffuse into and/or evaporate out from the silicone.

Please refer to AB203 for more details on VOCs and other incompatible chemicals.

Relative Spectral Distribution

Relative Intensity vs. Wavelength, MXC7-PWxx

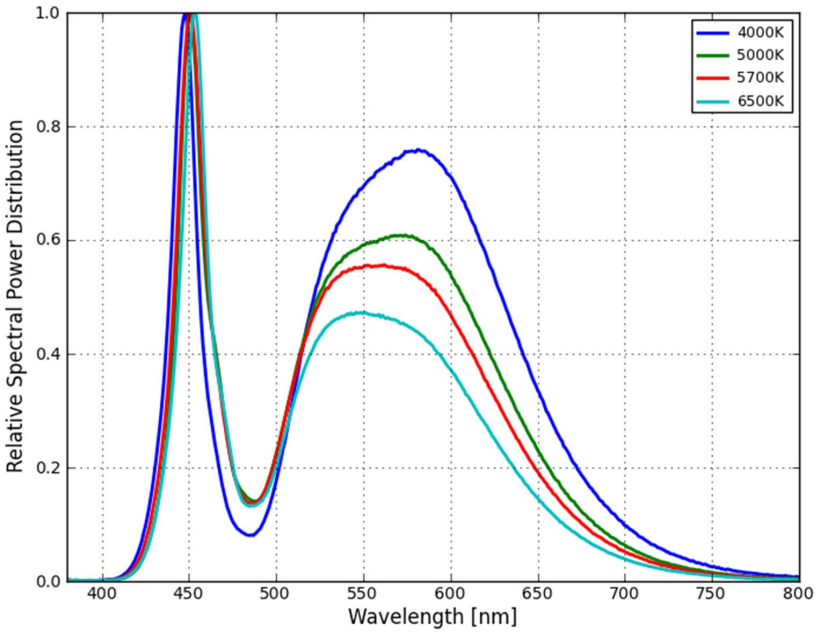


Figure 3a. Typical color spectrum of MXC7-PWxx emitter, integrated measurement at solder pad temperature = 25°C, forward current = 100mA.

Relative Intensity vs. Wavelength, MXC8-PWxx

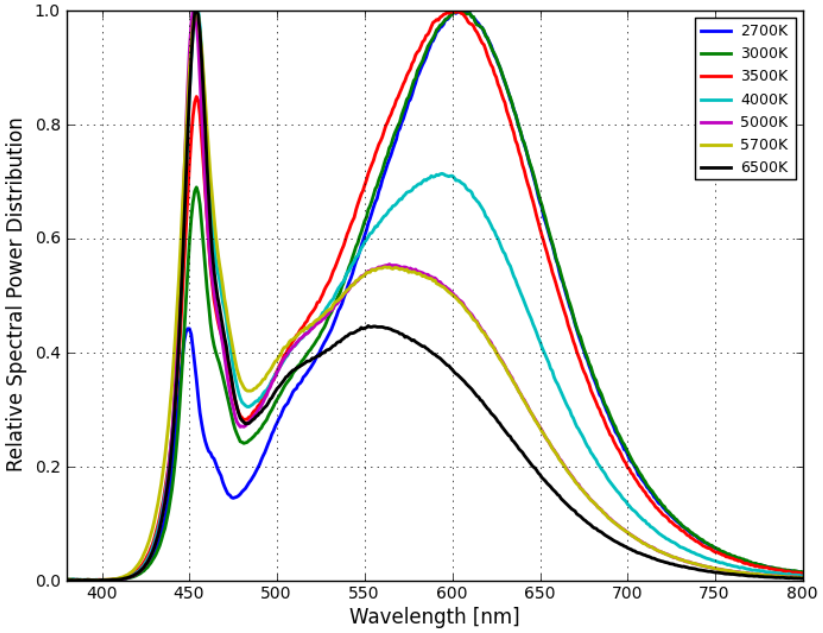


Figure 3b. Typical color spectrum of MXC8-PWxx emitter, integrated measurement at solder pad temperature = 25°C, forward current = 100mA.

Relative Intensity vs. Wavelength, MXC9-PWxx

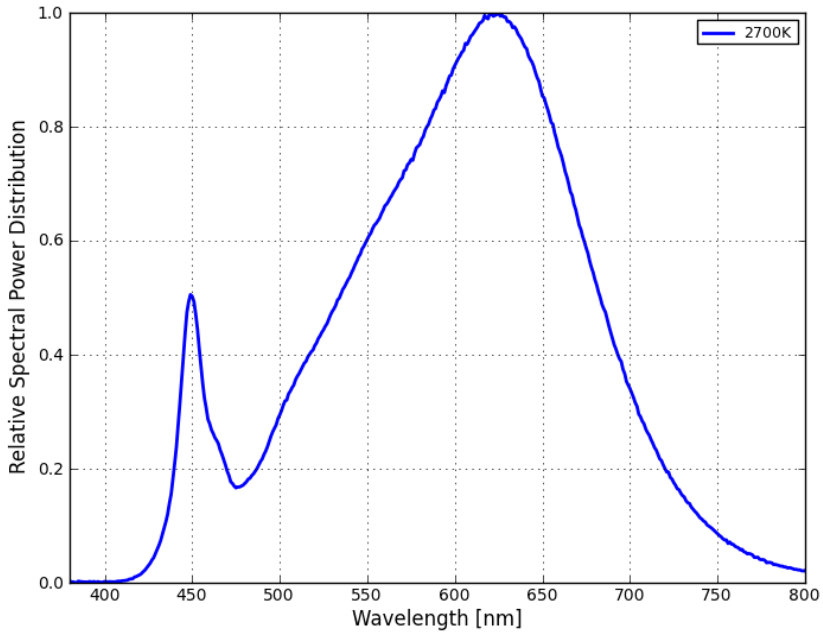


Figure 3c. Typical color spectrum of MXC9-PWxx emitter, integrated measurement at solder pad temperature = 25°C, forward current = 100mA.

Light Output Characteristics

Relative Flux over Temperature
MXCx-PWxx

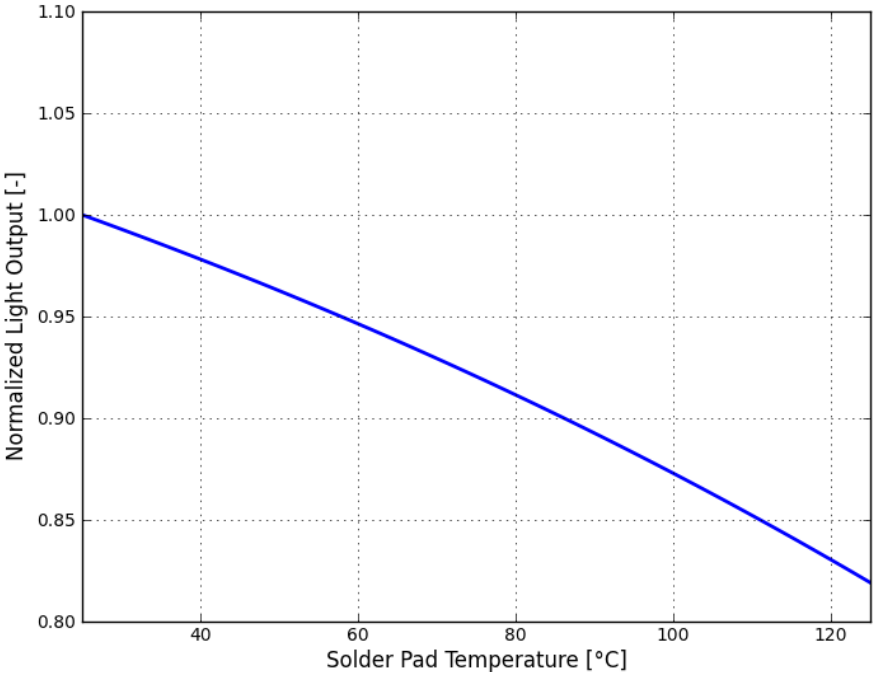


Figure 4. Typical relative light output vs. solder pad temperature, forward current = 100mA.

Relative Flux vs. Forward Current
MXCx-PWxx

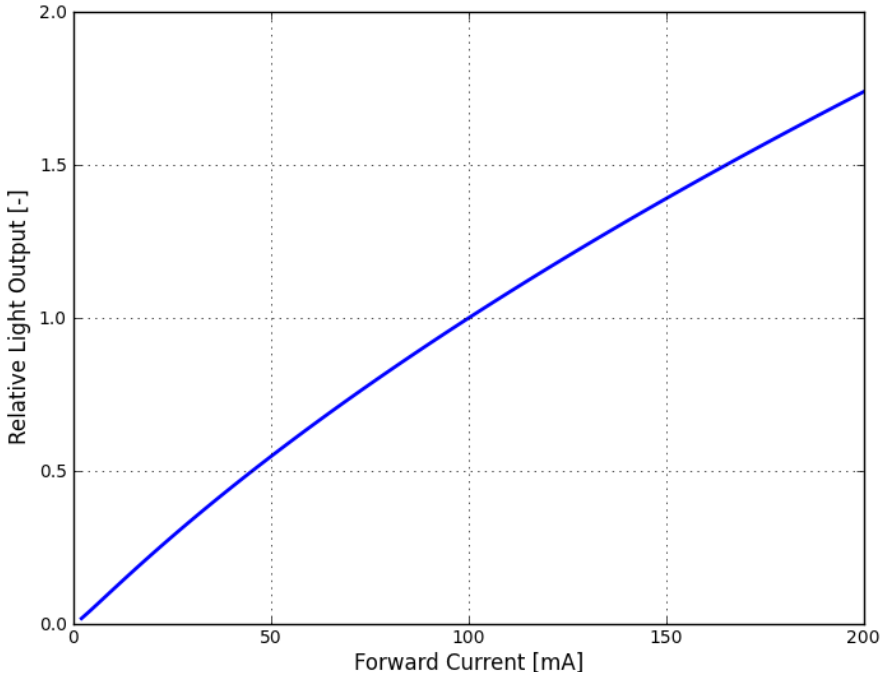


Figure 5. Typical relative luminous flux vs. forward current, solder pad temperature = 25°C.

Luminous Efficacy Characteristics

Relative Luminous Efficacy vs. Forward Current
MXCx-PWxx

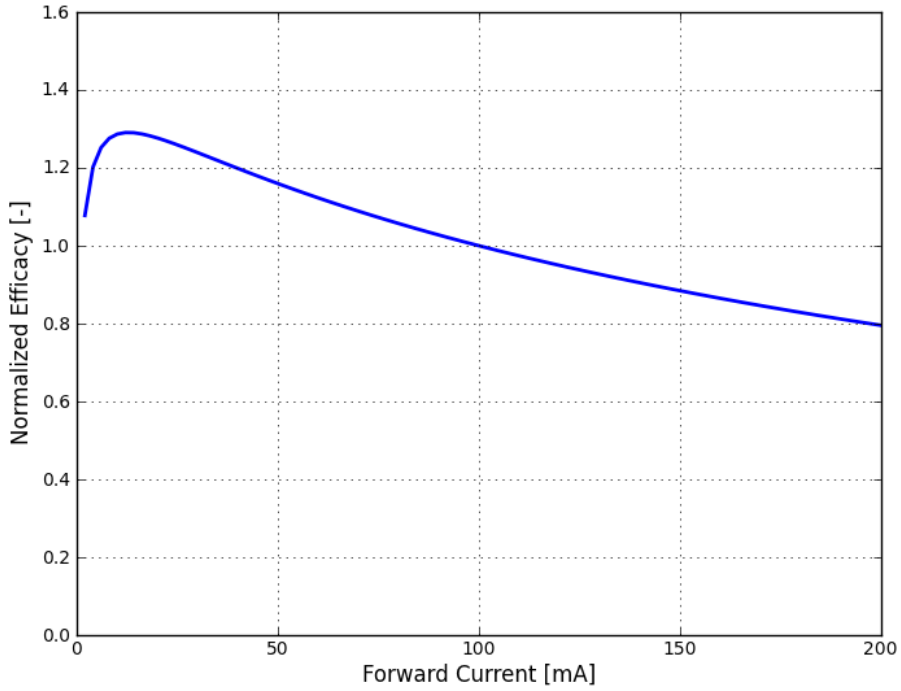


Figure 6. Typical emitter efficacy versus forward current, solder pad temperature = 25°C.

Forward Current Characteristics

Forward Current vs. Forward Voltage
MXCx-PWxx

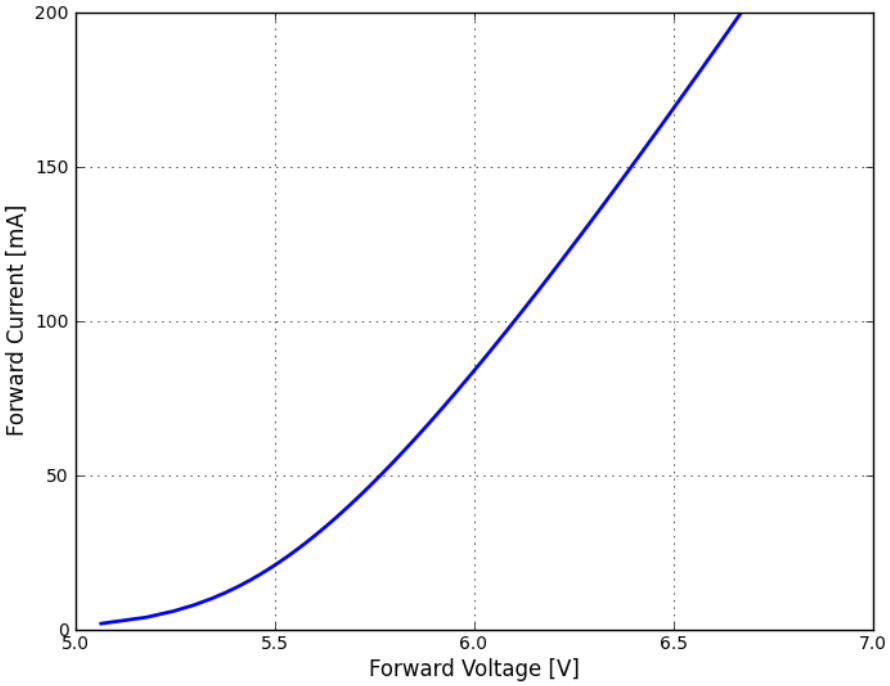


Figure 7. Typical forward current vs. forward voltage, solder pad temperature = 25°C.

Typical Radiation Patterns

Radiation Pattern in Cartesian Coordinate System

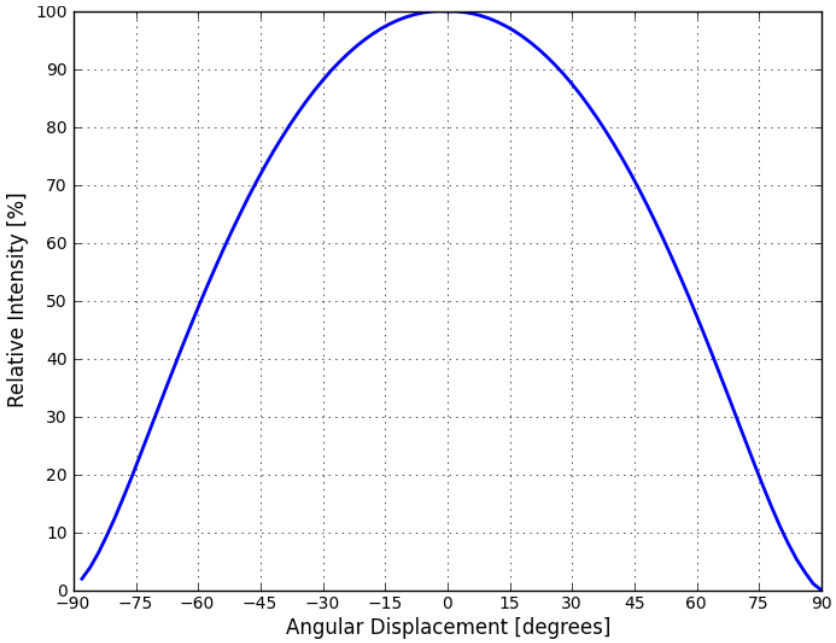


Figure 8. Typical representative spatial radiation pattern.

Radiation Pattern in Polar Coordinate System

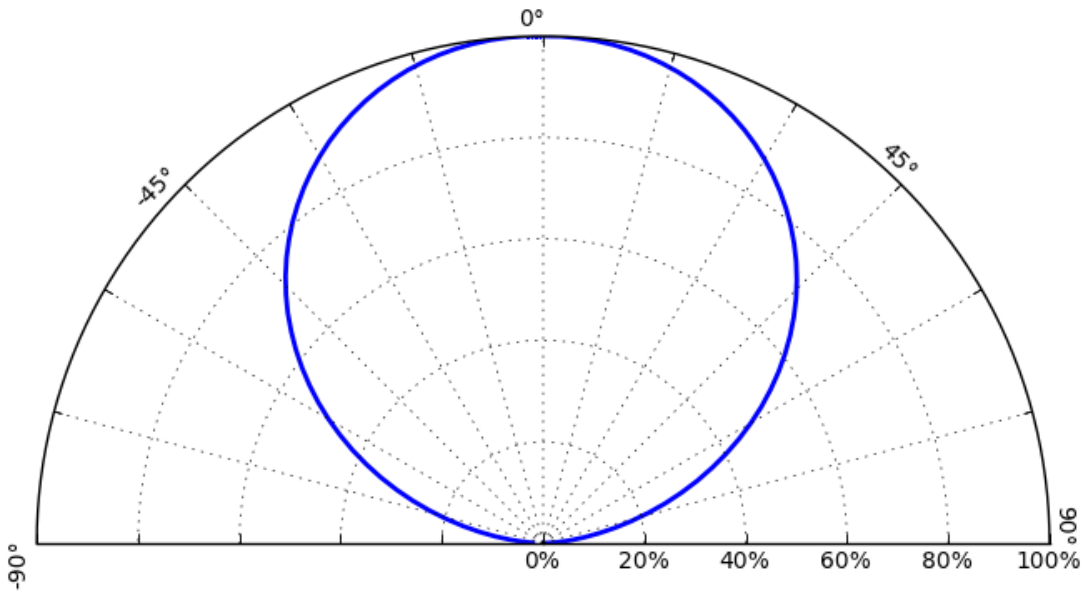


Figure 9. Typical polar plot of radiation pattern.

Emitter Pocket Tape Packaging

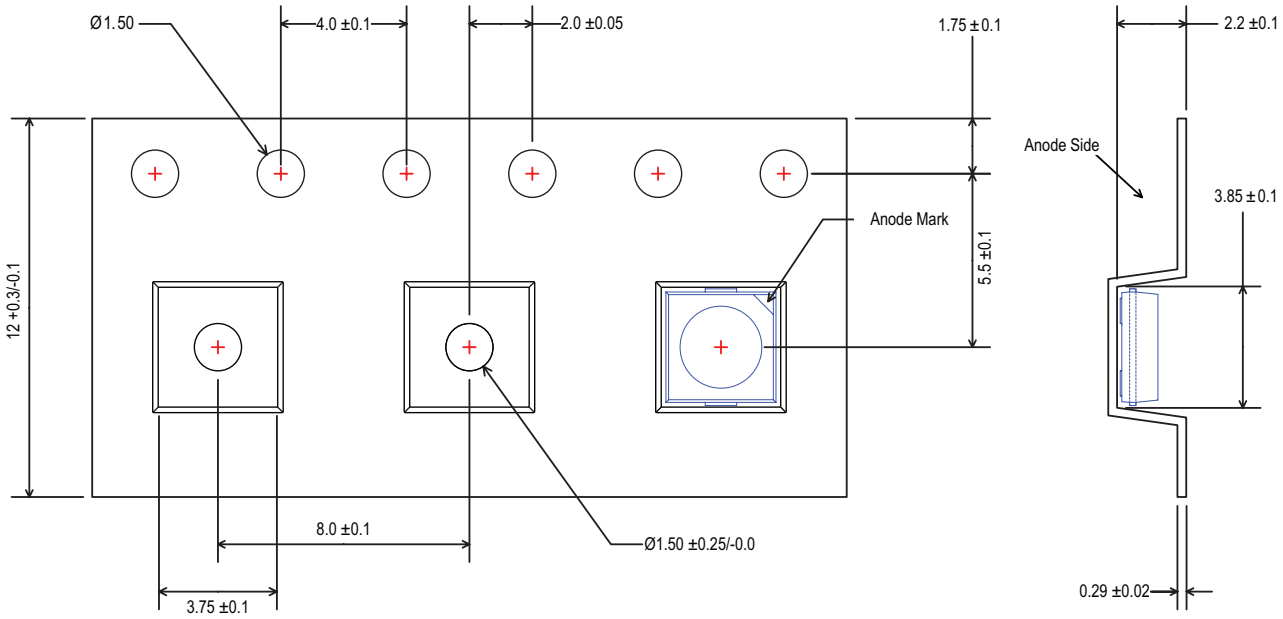


Figure 10. Emitter pocket tape packaging.

Notes for Figure 10:
1. All dimensions are in millimeters
2. Empty component pockets sealed with top cover tape
3. The maximum number of consecutive missing LEDs is two.

Emitter Reel Packaging

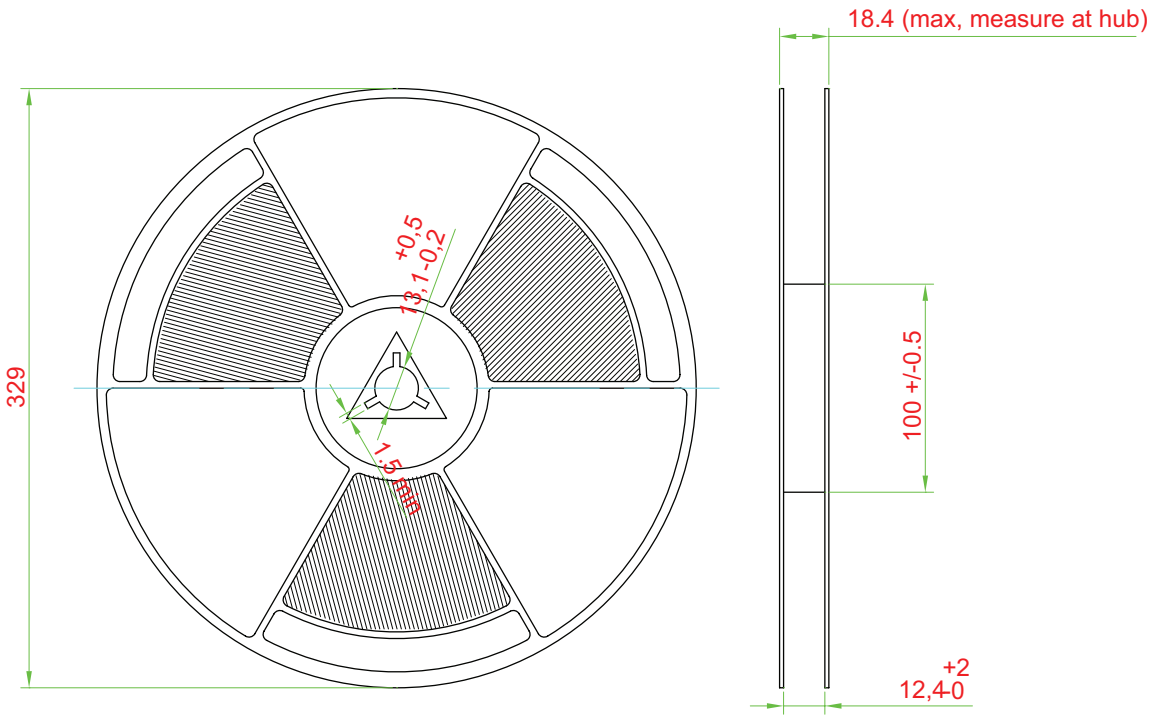


Figure 11. Emitter reel packaging.

Notes for Figure 11:

- All dimentions are in millimeters.
- Empty component pockets sealed with top cover tape.
- 329 mm reel - 5000 pieces per reel.
- Minimum packing quantity is 5000 pieces.
- The maximum number of consecutive missing LEDs is two.
- In accordance with EIA-481-1-B specification.

Product Binning and Labeling

Purpose of Product Binning

In the manufacturing of semiconductor products, there is a variation of performance around the average values given in the technical data sheets. For this reason, Lumileds bins the LED components for luminous flux, color and forward voltage (V_f).

Decoding Product Bin Labeling

LUXEON Mid-Power emitters are labeled using a four digit alphanumeric code (CAT code) depicting the bin values for emitters packaged on a single reel. All emitters packaged within a reel are of the same 3-variable bin combination. Using these codes, it is possible to determine optimum mixing and matching of products for consistency in a given application.

Reels of 2700K, 3000K, 3500K, 4000K, 5000K, 5700K and 6500K emitters are labeled with a four or five digit alphanumeric CAT code following the format below.

A B C D or A x B C D

Where:

A = Flux bin (D, etc.)

x = Lumileds internal use

B and C = Color bin (For example 51, 52, 53, 54, 55, 56 or 5D, 5E, 8F, 8G, 8H, 8J, 8K, 8L, 8M)

D = V_f bin

Luminous Flux Bins

Table 7 lists the standard photometric luminous flux bins for LUXEON Mid-Power emitters (tested and binned at 100mA).

Although several bins are outlined, product availability in a particular bin varies by production run and by product performance.

Not all bins are available in all colors.

Table 7. Flux Bins

Bin Code	Minimum Photometric Flux (lm)	Maximum Photometric Flux (lm)
A	55	60
B	60	65
C	65	70
D	70	75
E	75	80
F	80	85
G	85	90
H	90	95
J	95	100
K	100	105
L	105	110
M	110	115
N	115	120

Tested and binned at 25°C, If=100mA. Tester tolerance: ±7.5%.

Forward Voltage Bins

Table 8. V_f Bins

Bin Code	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
F	5.6	5.8
G	5.8	6
H	6	6.2
J	6.2	6.4
K	6.4	6.6
L	6.6	6.8

Tested and binned at 25°C, If = 100mA. Tester tolerance: ±0.10V.

Color Bin Structure

MXCx-PW27-xxxx 1/6th Color Bin Structure

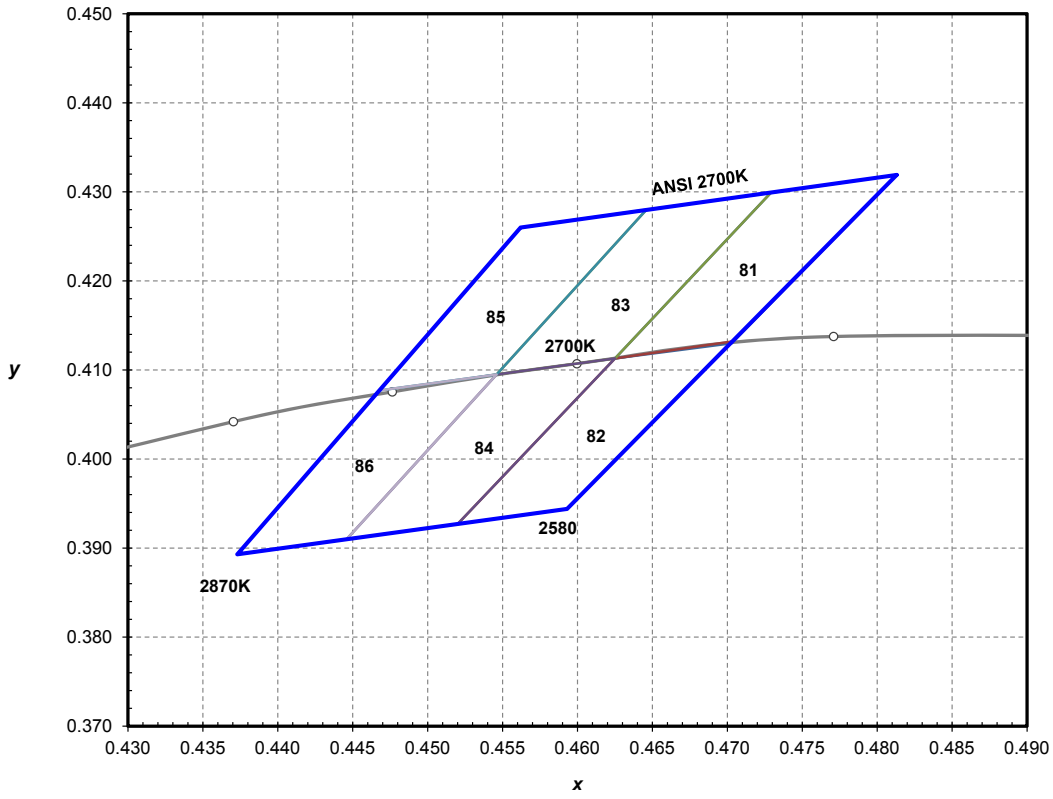


Figure 12. ANSI 2700K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 9.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW27-xxxx Emitter					
Bin Code	x	y	Bin Code	x	y
81	0.4625 0.4729 0.4813 0.4703	0.4113 0.4299 0.4319 0.4132	84	0.4446 0.4546 0.4625 0.4520	0.3910 0.4095 0.4113 0.3927
82	0.4520 0.4625 0.4703 0.4593	0.3927 0.4113 0.4132 0.3944	85	0.4468 0.4562 0.4646 0.4546	0.4077 0.4260 0.4280 0.4095
83	0.4546 0.4646 0.4729 0.4625	0.4095 0.4280 0.4299 0.4113	86	0.4373 0.4468 0.4546 0.4446	0.3893 0.4077 0.4095 0.3910

Notes for Table 9:

1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW27-xxxx 1/9th Color Bin Structure

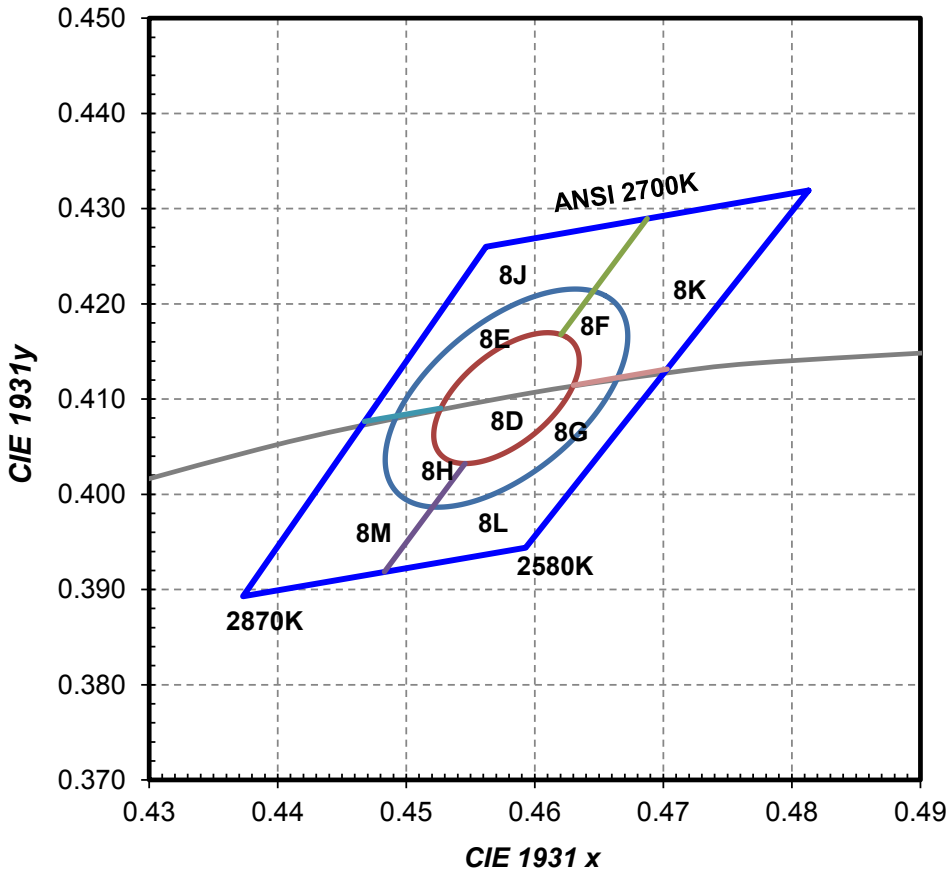


Figure 13. ANSI 2700K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 10.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
2700K	Single 3-step MacAdam ellipse	(0.4578, 0.4101)	0.00810	0.00420	53.70°
2700K	Single 5-step MacAdam ellipse	(0.4578, 0.4101)	0.01350	0.00700	53.70°

Notes for Table 10:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

Color Bin Structure, Continued

MXCx-PW30-xxxxx 1/6th Color Bin Structure

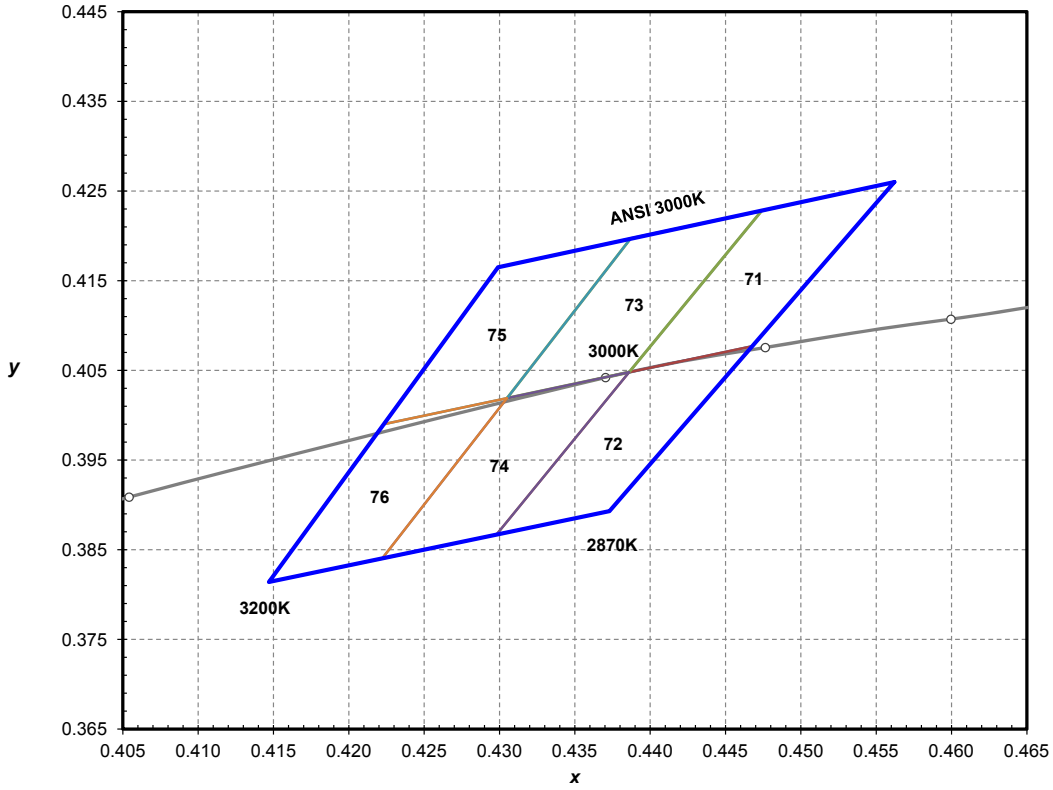


Figure 14. ANSI 3000K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 11.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW30-xxxx Emitter					
Bin Code	x	y	Bin Code	x	y
71	0.4386 0.4474 0.4562 0.4468	0.4048 0.4228 0.4260 0.4077	74	0.4222 0.4305 0.4386 0.4298	0.3840 0.4019 0.4048 0.3867
72	0.4298 0.4386 0.4468 0.4373	0.3867 0.4048 0.4077 0.3893	75	0.4223 0.4299 0.4387 0.4305	0.3990 0.4165 0.4197 0.4019
73	0.4305 0.4387 0.4474 0.4386	0.4019 0.4197 0.4228 0.4048	76	0.4147 0.4223 0.4305 0.4222	0.3814 0.3990 0.4019 0.3840

Notes for Table 11:

1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW30-xxxxx 1/9th Color Bin Structure

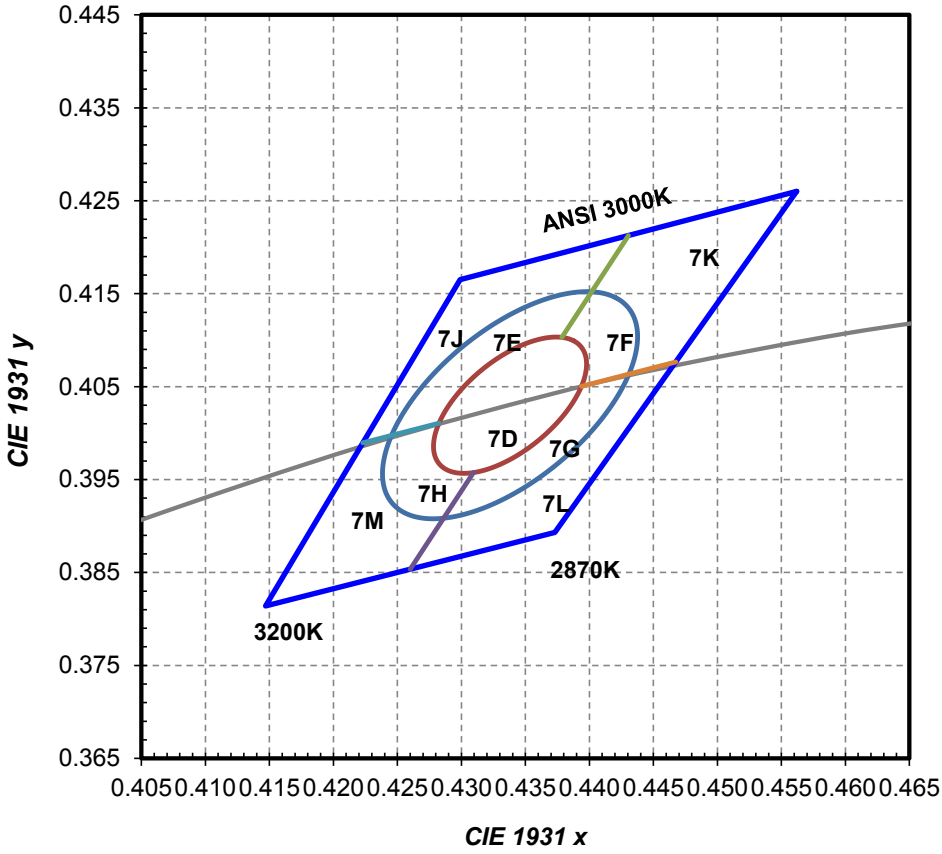


Figure 15. ANSI 3000K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 12.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
3000K	Single 3-step MacAdam ellipse	(0.4338, 0.403)	0.00834	0.00408	53.22°
3000K	Single 5-step MacAdam ellipse	(0.4338, 0.403)	0.01390	0.00680	53.22°

Notes for Table 12:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

Color Bin Structure, Continued

MXCx-PW35-xxxxx 1/6th Color Bin Structure

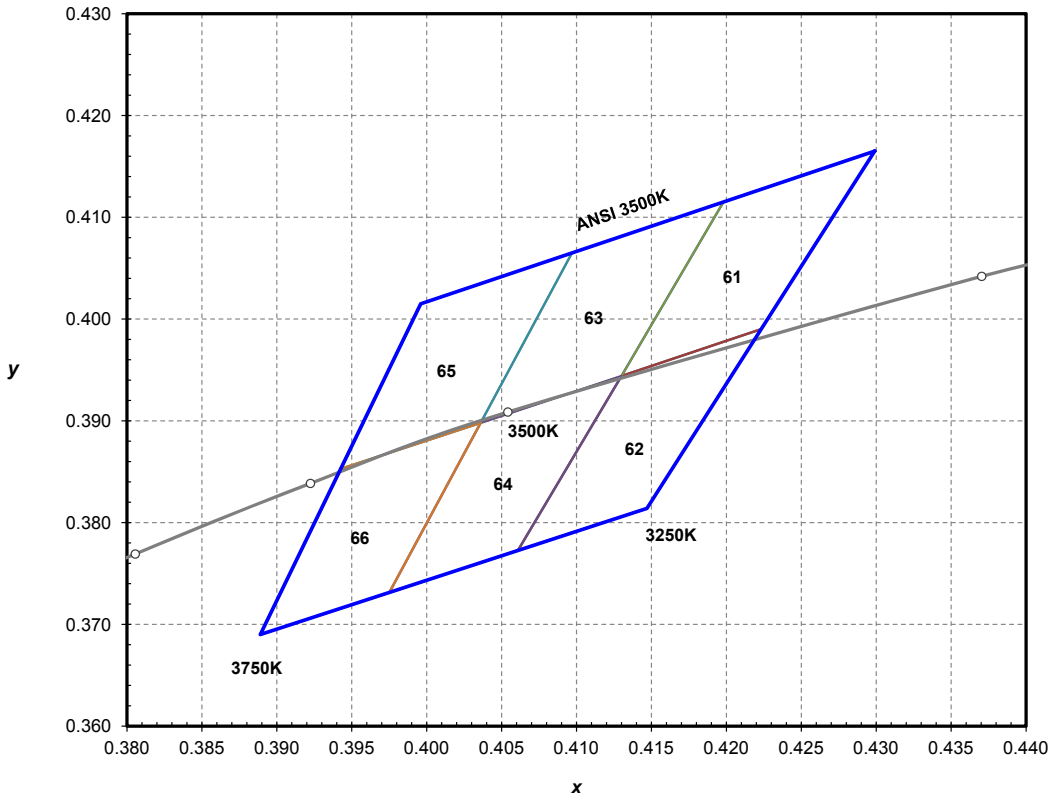


Figure 16. ANSI 3500K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 13.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW35-xxxx Emitter					
Bin Code	x	y	Bin Code	x	y
61	0.4130 0.4198 0.4299 0.4223	0.3944 0.4115 0.4165 0.3990	64	0.3975 0.4036 0.4130 0.4061	0.3731 0.3898 0.3944 0.3773
62	0.4061 0.4130 0.4223 0.4147	0.3773 0.3944 0.3990 0.3814	65	0.3943 0.3996 0.4097 0.4036	0.3853 0.4015 0.4065 0.3898
63	0.4036 0.4097 0.4198 0.4130	0.3898 0.4065 0.4115 0.3944	66	0.3889 0.3943 0.4036 0.3975	0.3690 0.3853 0.3898 0.3731

Notes for Table 13:

1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW35-xxxxx 1/9th Color Bin Structure

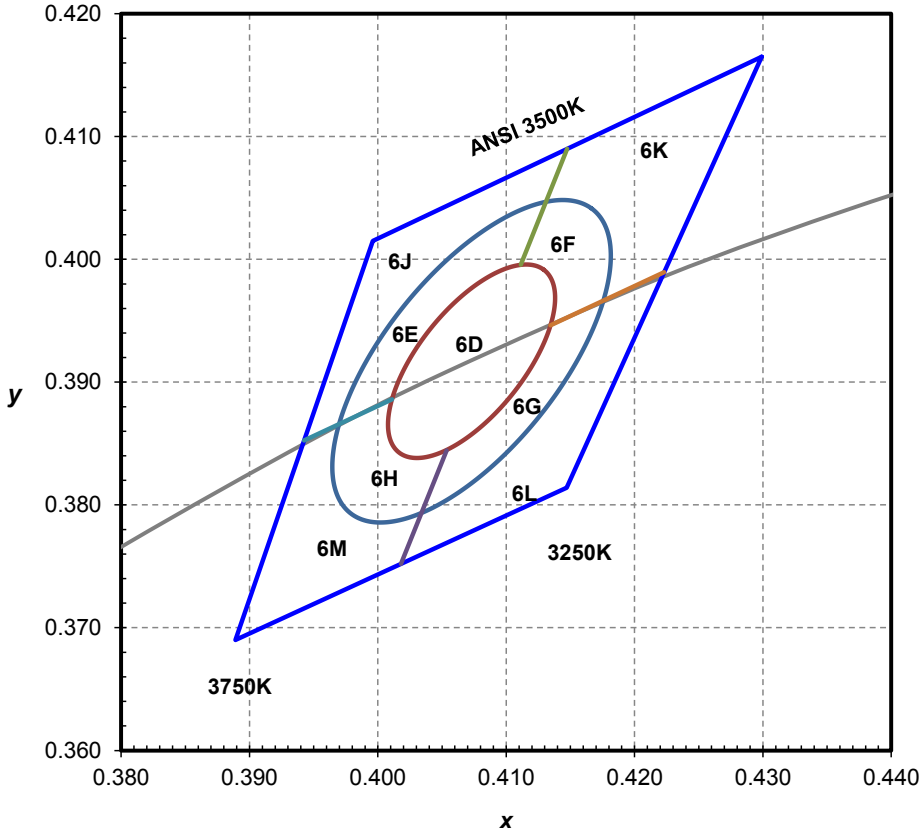


Figure 17. ANSI 3500K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 14.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
3500K	Single 3-step MacAdam ellipse	(0.4073, 0.3917)	0.00927	0.00414	53.22°
3500K	Single 5-step MacAdam ellipse	(0.4073, 0.3917)	0.01545	0.00690	53.22°

Notes for Table 14:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

Color Bin Structure, Continued

MXCx-PW40-xxxx 1/6th Color Bin Structure

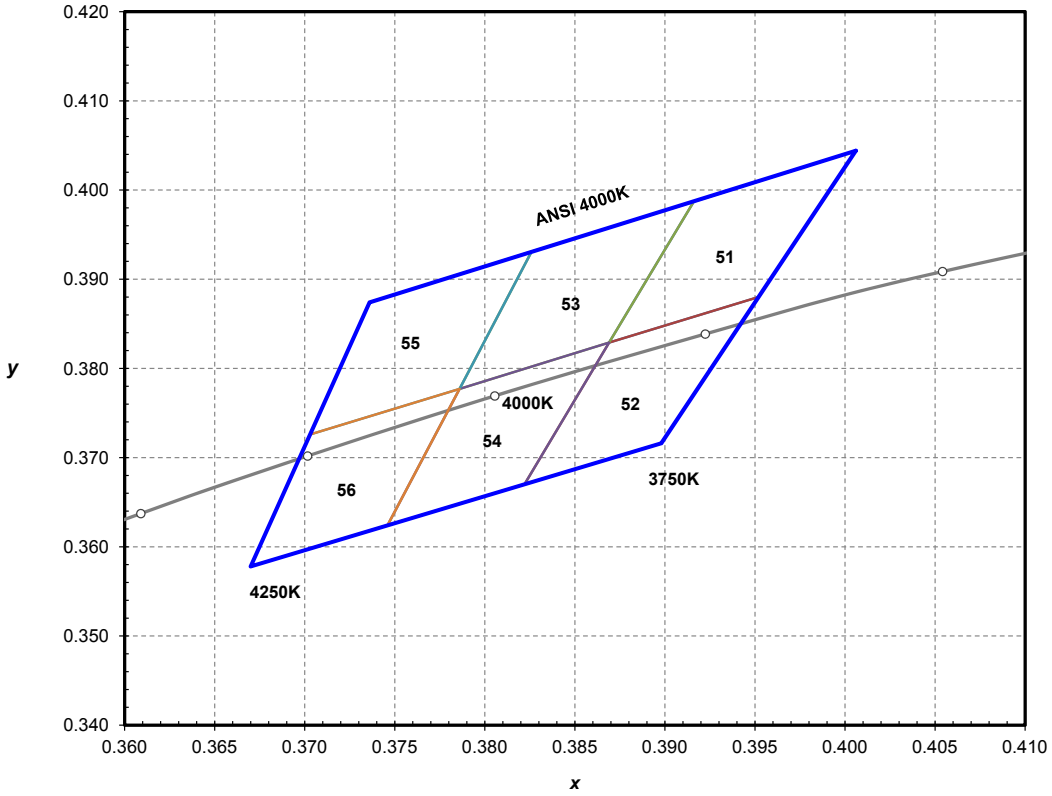


Figure 18. ANSI 4000K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 15.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW40-xxxxx Emitter					
Bin Code	x	y	Bin Code	x	y
51	0.3869 0.3916 0.4006 0.3952	0.3829 0.3987 0.4044 0.3880	54	0.3746 0.3786 0.3869 0.3822	0.3624 0.3777 0.3829 0.3670
52	0.3822 0.3869 0.3952 0.3898	0.3670 0.3829 0.3880 0.3716	55	0.3703 0.3736 0.3826 0.3786	0.3726 0.3874 0.3931 0.3777
53	0.3786 0.3826 0.3916 0.3869	0.3777 0.3931 0.3987 0.3829	56	0.3670 0.3703 0.3786 0.3746	0.3578 0.3726 0.3777 0.3624

Notes for Table 15:

1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW40-xxxx 1/9th Color Bin Structure

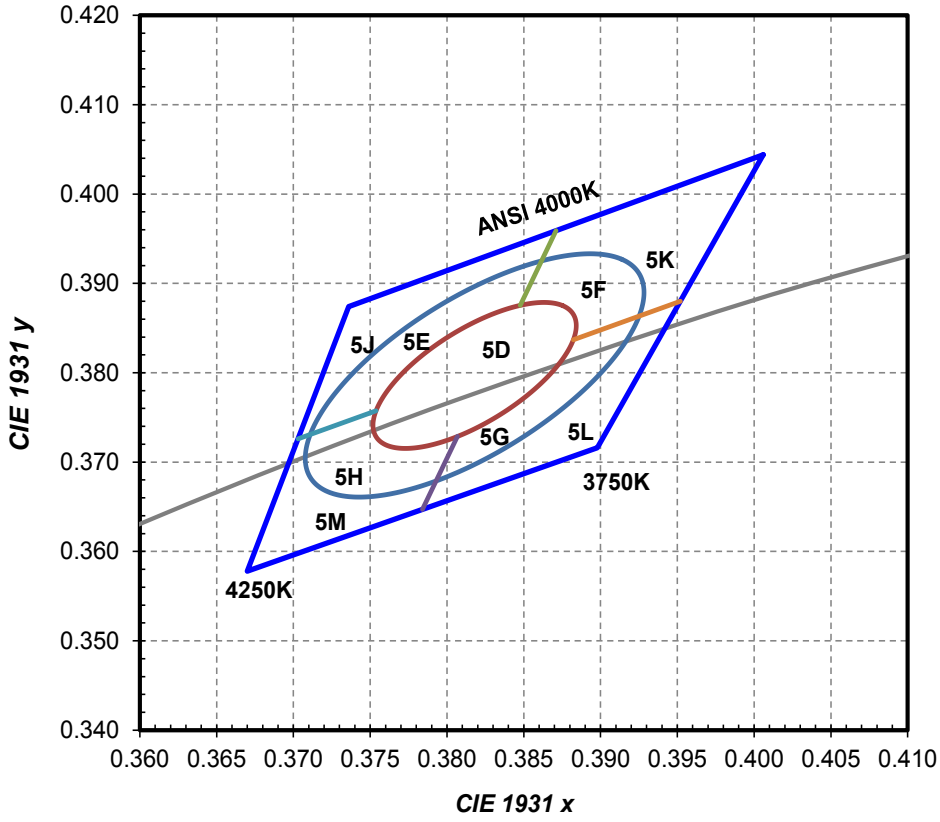


Figure 19. ANSI 4000K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 16.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
4000K	Single 3-step MacAdam ellipse	(0.3818, 0.3797)	0.00939	0.00402	53.72°
4000K	Single 5-step MacAdam ellipse	(0.3818, 0.3797)	0.01565	0.00670	53.72°

Notes for Table 16:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

Color Bin Structure, Continued

MXCx-PW50-xxxx 1/6th Color Bin Structure

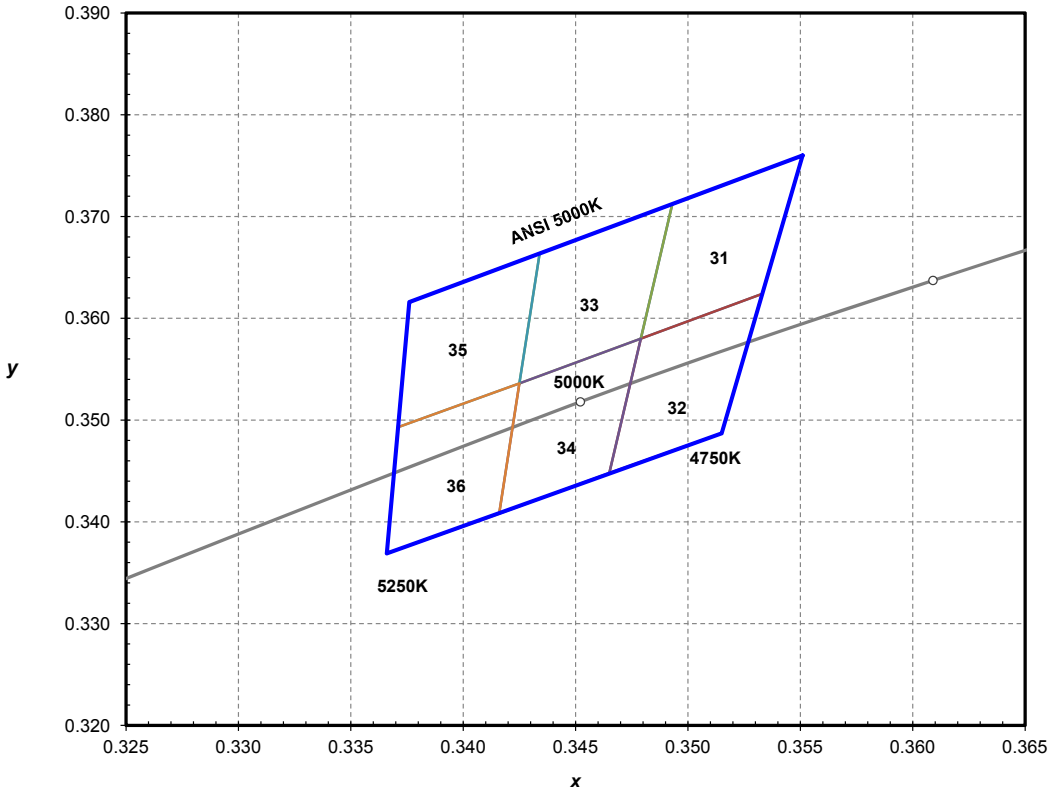


Figure 20. ANSI 5000K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 17.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW50-xxxx Emitter					
Bin Code	x	y	Bin Code	x	y
31	0.3479 0.3493 0.3551 0.3533	0.3580 0.3712 0.3760 0.3624	34	0.3416 0.3425 0.3479 0.3465	0.3408 0.3536 0.3580 0.3448
32	0.3465 0.3479 0.3533 0.3515	0.3448 0.3580 0.3624 0.3487	35	0.3371 0.3376 0.3434 0.3425	0.3493 0.3616 0.3664 0.3536
33	0.3425 0.3434 0.3493 0.3479	0.3536 0.3664 0.3712 0.3580	36	0.3366 0.3371 0.3425 0.3416	0.3369 0.3493 0.3536 0.3408

Notes for Table 17:

1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW50-xxxx 1/9th Color Bin Structure

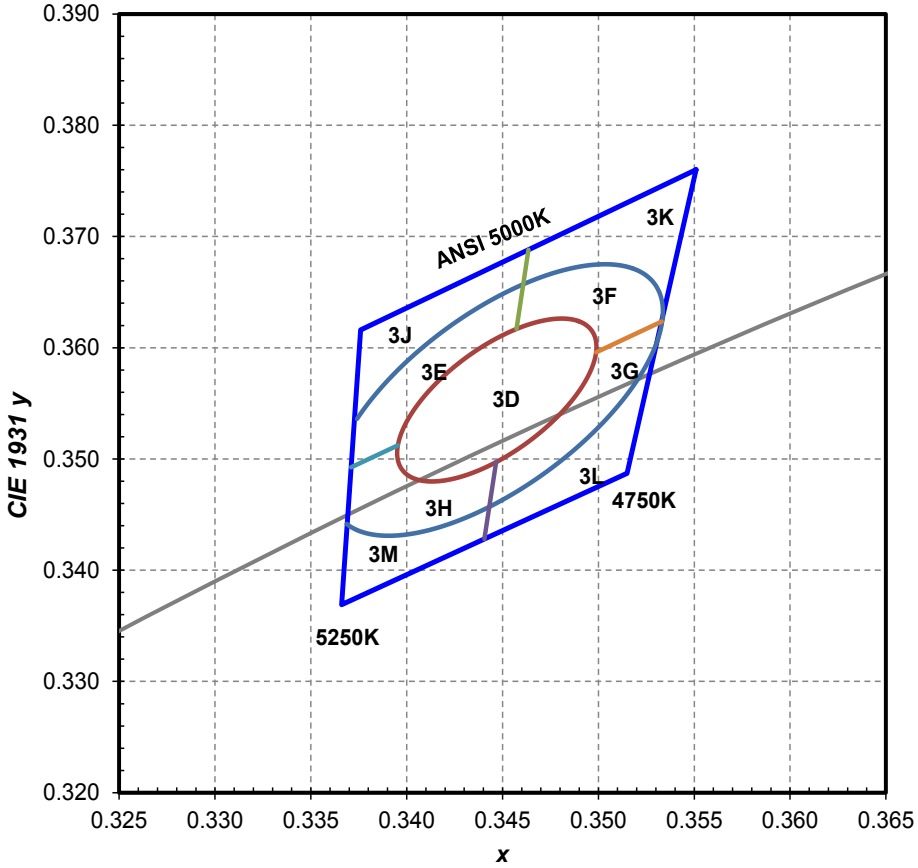


Figure 21. ANSI 5000K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 18.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
5000K	Single 3-step MacAdam ellipse	(0.3447, 0.3553)	0.00822	0.00354	59.62°
5000K	Single 5-step MacAdam ellipse	(0.3447, 0.3553)	0.01370	0.00590	59.62°

Notes for Table 18:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

Color Bin Structure, Continued

MXCx-PW57-xxxxx 1/6th Color Bin Structure

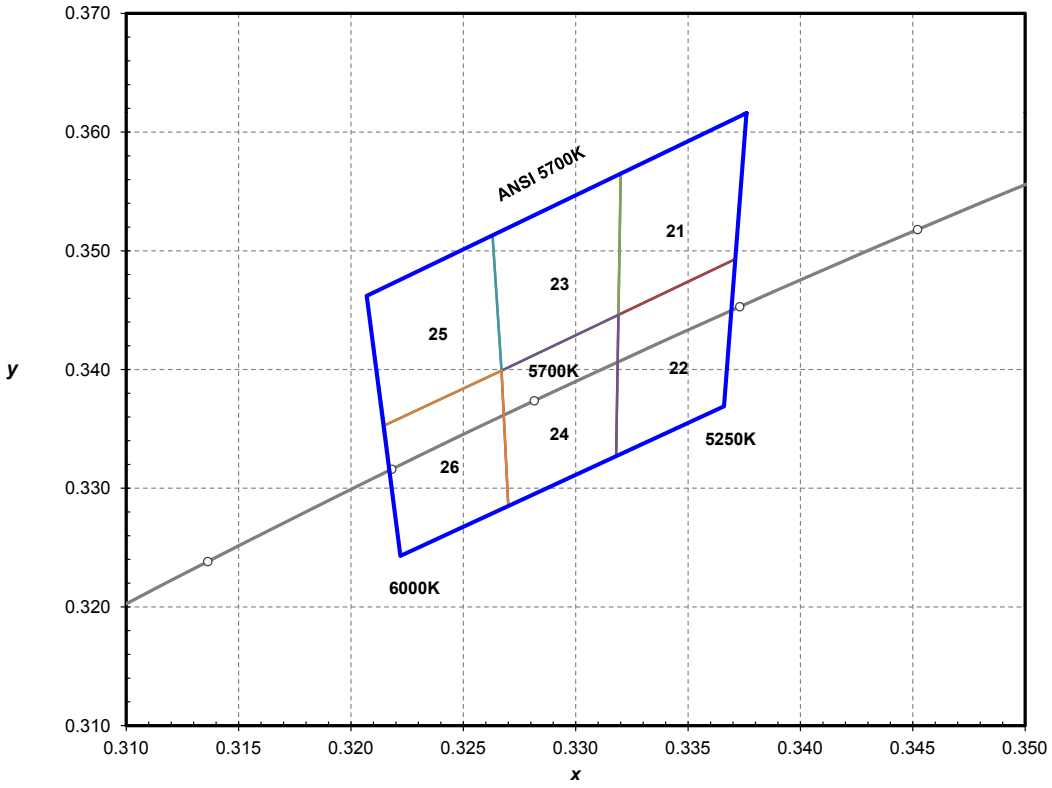


Figure 22. ANSI 5700K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 19.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW57-xxxxx Emitter					
Bin Code	x	y	Bin Code	x	y
21	0.3319 0.3320 0.3376 0.3371	0.3446 0.3565 0.3616 0.3493	24	0.3270 0.3267 0.3319 0.3318	0.3285 0.3399 0.3446 0.3327
22	0.3318 0.3319 0.3371 0.3366	0.3327 0.3446 0.3493 0.3369	25	0.3215 0.3207 0.3263 0.3267	0.3353 0.3462 0.3513 0.3399
23	0.3267 0.3263 0.3320 0.3319	0.3399 0.3513 0.3565 0.3446	26	0.3222 0.3215 0.3267 0.3270	0.3243 0.3353 0.3399 0.3285

Notes for Table 19:
1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW57-xxxxx 1/9th Color Bin Structure

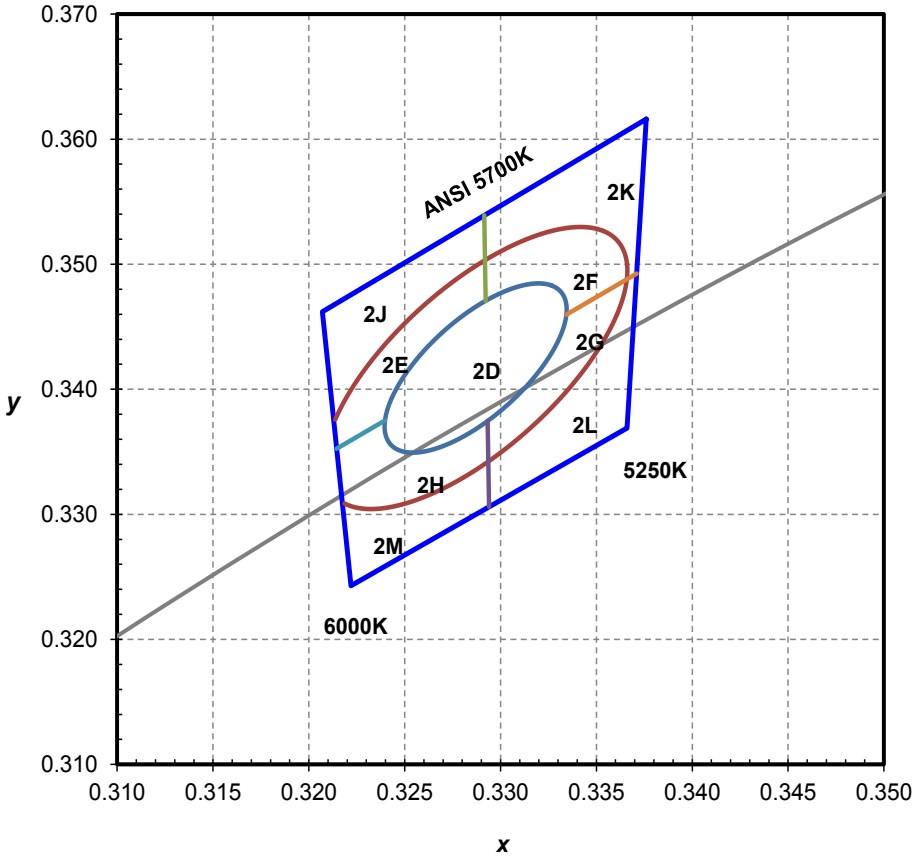


Figure 23. ANSI 5700K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 20.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
5700K	Single 3-step MacAdam ellipse	(0.3287, 0.3417)	0.00746	0.00320	59.09°
5700K	Single 5-step MacAdam ellipse	(0.3287, 0.3417)	0.01243	0.00533	59.09°

Notes for Table 20:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

Color Bin Structure, Continued

MXCx-PW65-xxxxx 1/6th Color Bin Structure

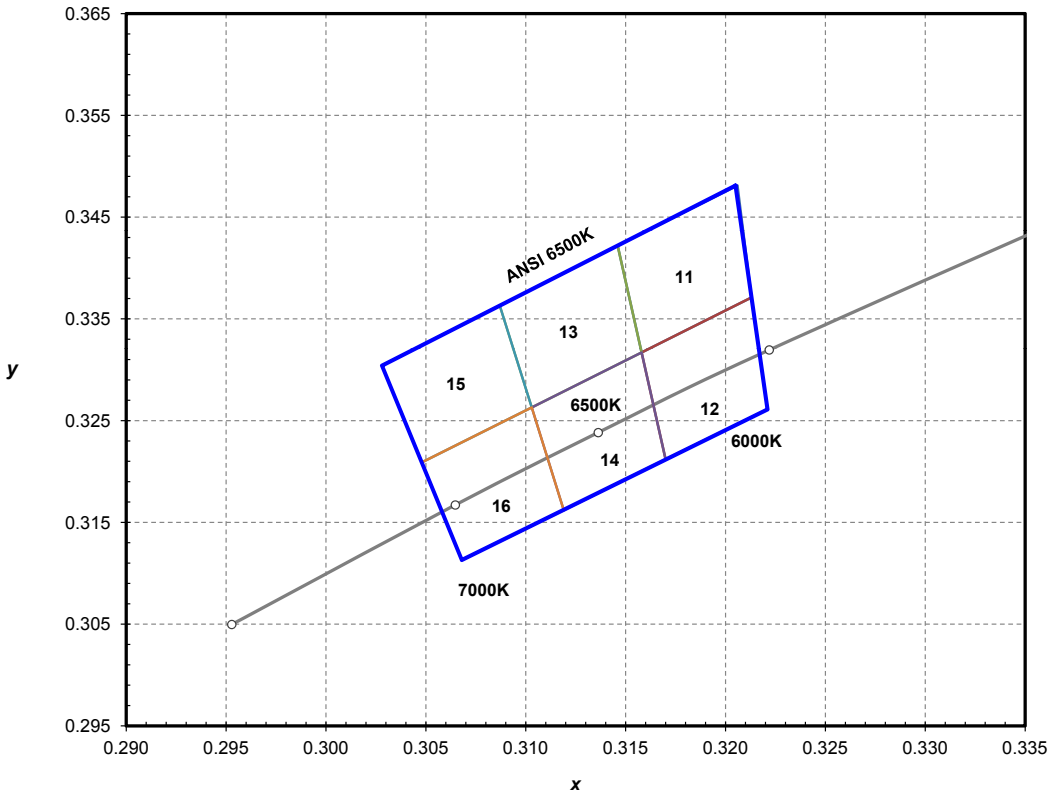


Figure 24. ANSI 6500K 1/6th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 21.

LUXEON Mid-Power ANSI 1/6 Color Bin Coordinates for MXCx-PW65-xxxxx Emitter					
Bin Code	x	y	Bin Code	x	y
11	0.3158 0.3146 0.3206 0.3213	0.3317 0.3422 0.3481 0.3371	14	0.3119 0.3103 0.3158 0.3170	0.3162 0.3263 0.3317 0.3212
12	0.3170 0.3158 0.3213 0.3221	0.3212 0.3317 0.3371 0.3261	15	0.3048 0.3028 0.3087 0.3103	0.3209 0.3304 0.3363 0.3263
13	0.3103 0.3087 0.3146 0.3158	0.3263 0.3363 0.3422 0.3317	16	0.3068 0.3048 0.3103 0.3119	0.3113 0.3209 0.3263 0.3162

Notes for Table 21:

1. Tested and binned at 25°C and If = 100 mA. Tester tolerance: +/- 0.01 in x and y coordinates

Color Bin Structure, Continued

MXCx-PW65-xxxxx 1/9th Color Bin Structure

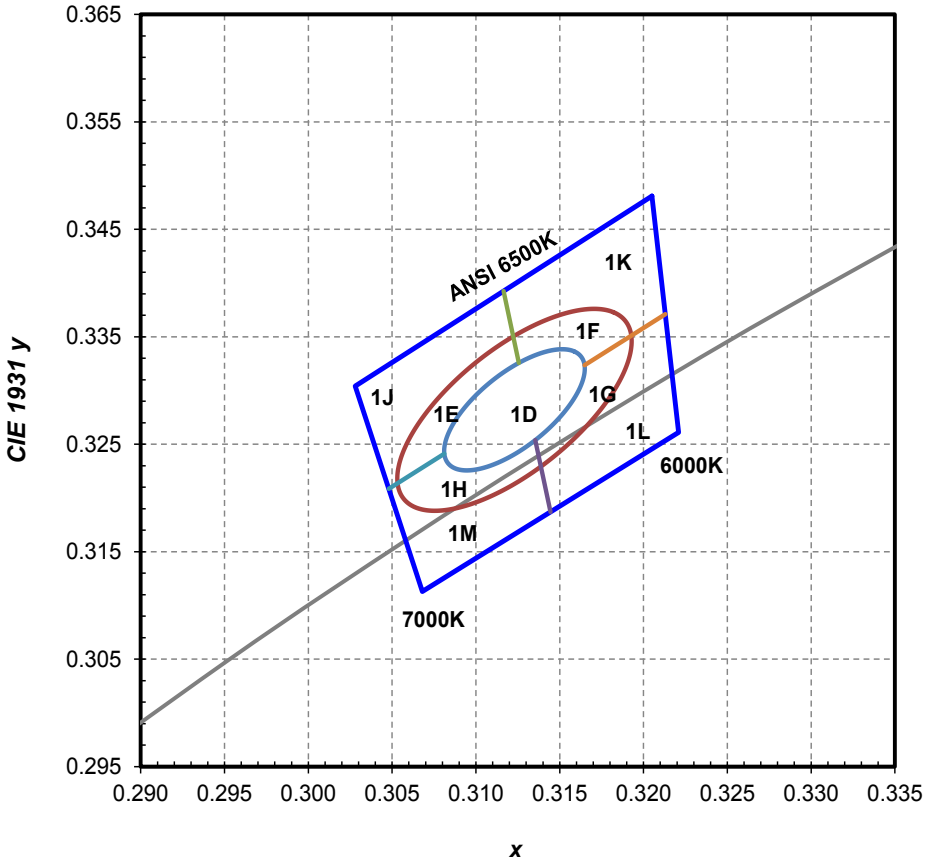


Figure 25. ANSI 6500K 1/9th color bin structure.

LUXEON Mid-Power Emitters are tested and binned by x,y coordinates.

Table 22.

Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
6500K	Single 3-step MacAdam ellipse	(0.3123, 0.3282)	0.00669	0.00285	58.57°
6500K	Single 5-step MacAdam ellipse	(0.3123, 0.3282)	0.01115	0.00475	58.57°

Notes for Table 22:

1. Tested and binned at 25°C and If = 100mA. Tester tolerance: +/- 0.01 in x and y coordinates.

About Lumileds

Lumileds is the light engine leader, delivering innovation, quality, and reliability.

For 100 years, Lumileds commitment to innovation has helped customers pioneer breakthrough products in the automotive, consumer and illumination markets.

Lumileds is shaping the future of light with our LEDs and automotive lamps, and helping our customers illuminate how people see the world around them.

To learn more about our portfolio of light engines visit www.lumileds.com.

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DS204 LUXEON 3535 2D
Product Datasheet 20150505

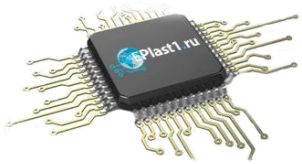
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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